

# Precision Timing with the CMS MIP Timing Detector

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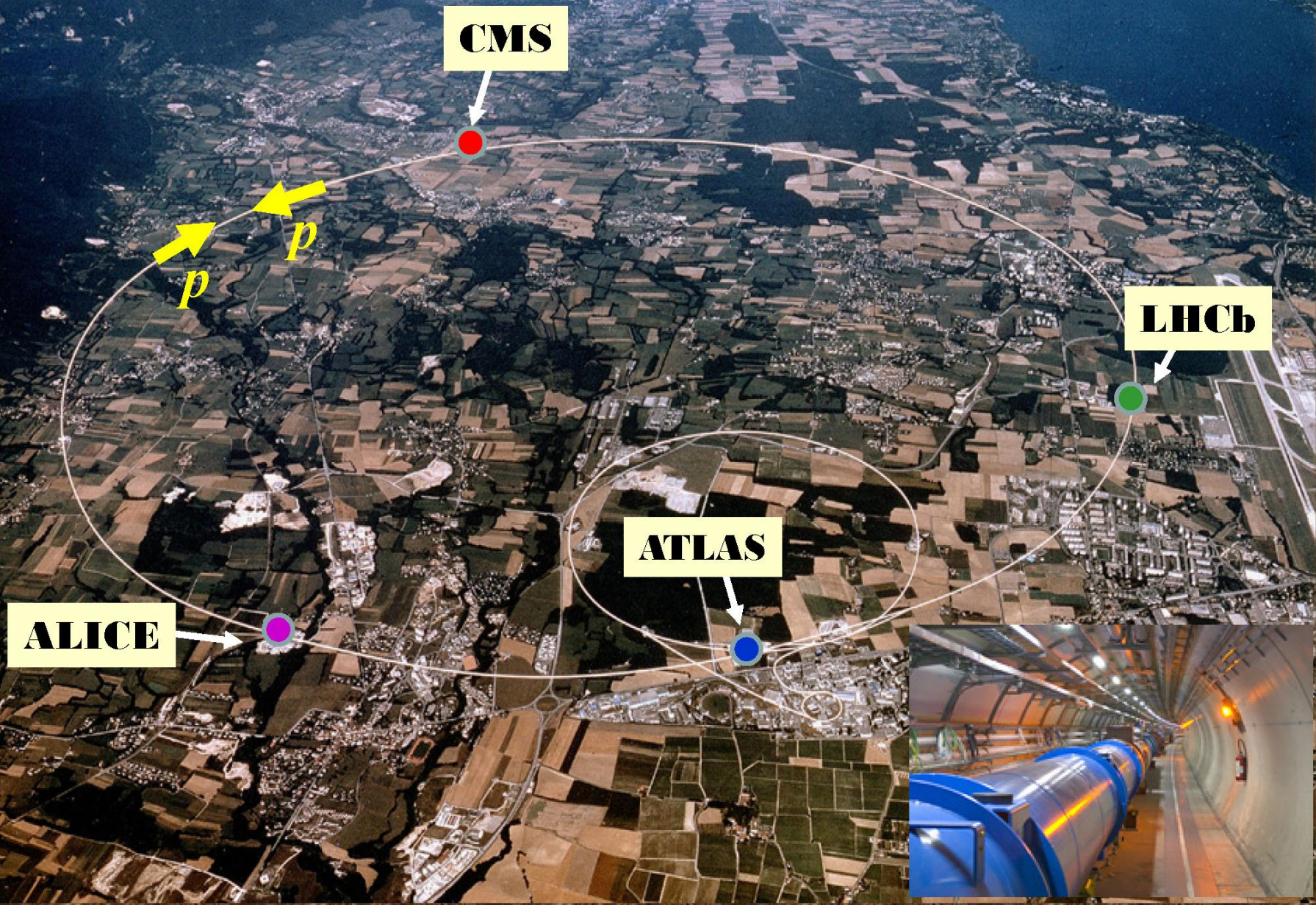
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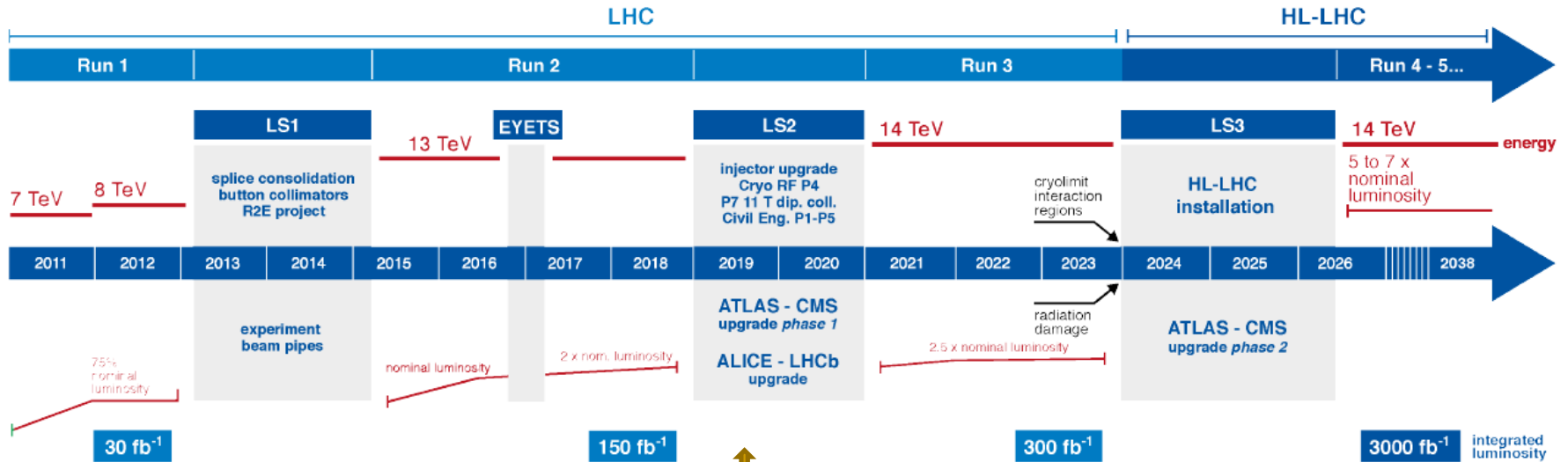
on behalf of the CMS Collaboration

PIC 2019 - Taipei

# Large Hadron Collider



# LHC / HL-LHC Plan



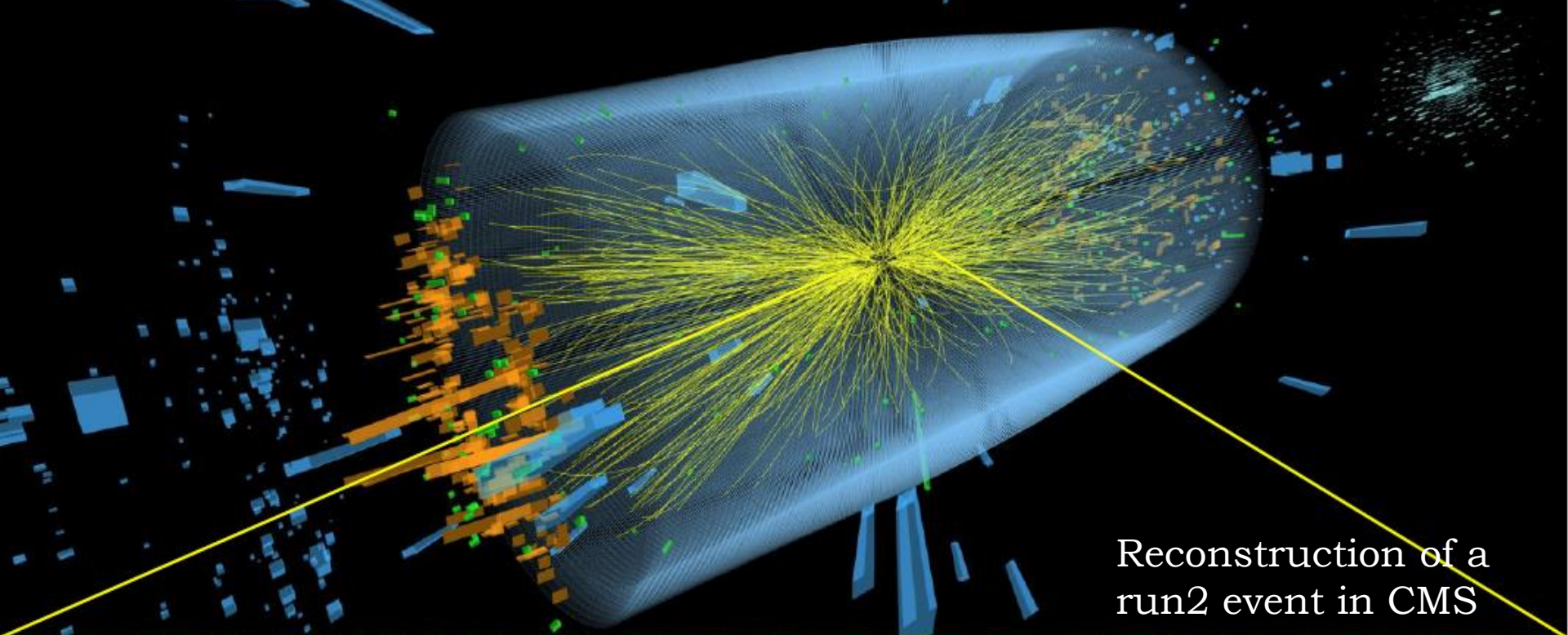
Higgs boson discovery

We are here.

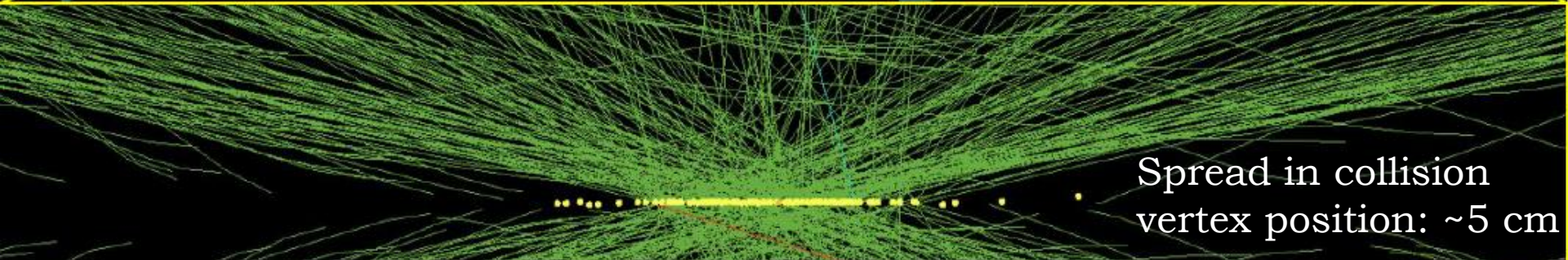
Very challenging for event reconstruction.

A ten times large dataset for physics and a real challenge for the detector radiation resistance.

	LHC	HL-LHC	
E =	7-14	14	TeV
$\mathcal{L}_{\text{peak}}$ =	2	5-7.5	$\cdot 10^{34} \text{cm}^{-2} \text{s}^{-1}$
$\text{PU}_{\text{peak}}$ =	40-60	<b>150-200</b>	
$\int \mathcal{L} =$	$\geq 50$	<b>250-320</b>	fb <sup>-1</sup> /year
$\int \mathcal{L} =$	300-500	3000-4000	fb <sup>-1</sup> total



Reconstruction of a  
run2 event in CMS



Spread in collision  
vertex position: ~5 cm

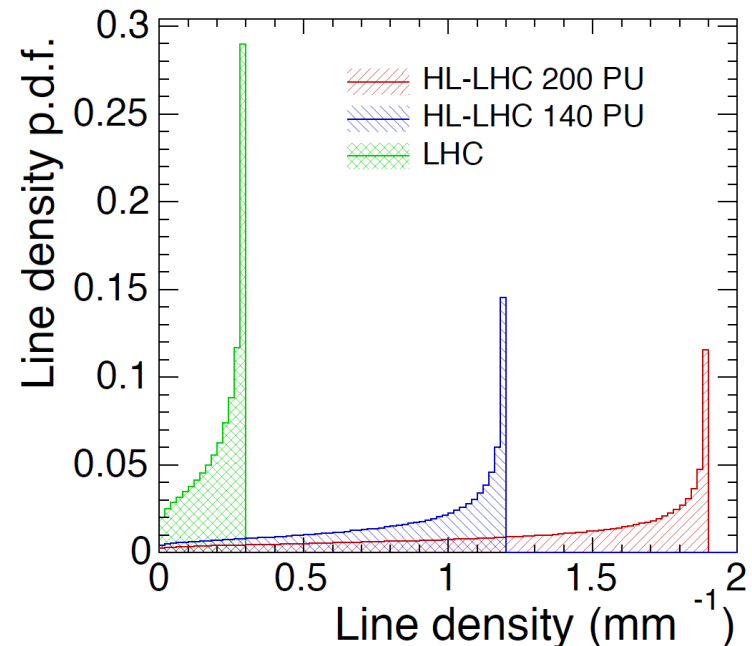
**Number of collisions per bunch crossing (pile-up):**

- Phase I LHC: ~40 collisions
- High Luminosity LHC: 140-200 collisions

# [ The HL-LHC challenge ]

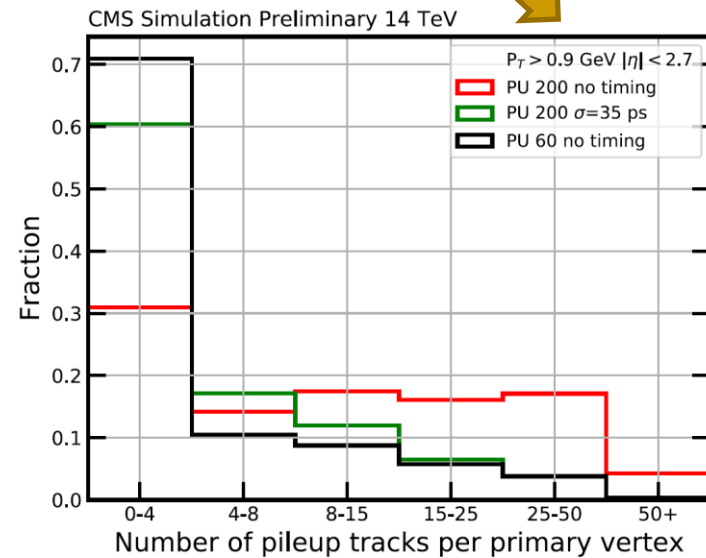
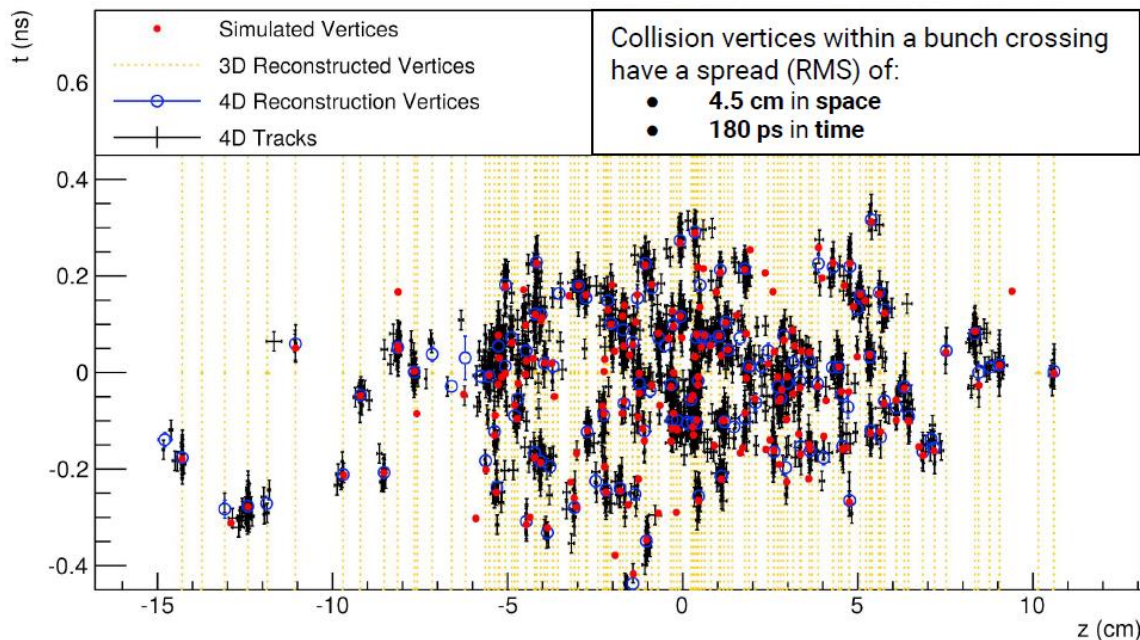
- Up to 5x higher vertex density
- Optimal cut at 1 mm for track-vertex compatibility
- Vertex density  $> 1 \text{ mm}^{-1}$  means pile-up contamination and event reconstruction degradation

Probability density functions of the line density along the beam axis.



# A Detector for MIP Timing

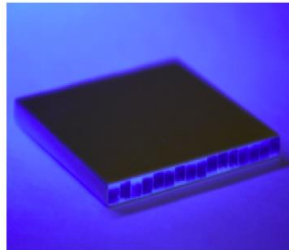
- Approach: time tagging tracks with 30-50 ps resolution
  - 3D  $\rightarrow$  4D vertex reconstruction
  - time compatibility for track-vertex association
- Goal: **reduce the actual Phase2 pile-up to the current Phase1 size** by slicing the beam spot in time slices.



# Design of the CMS MTD (Mip Timing Detector)

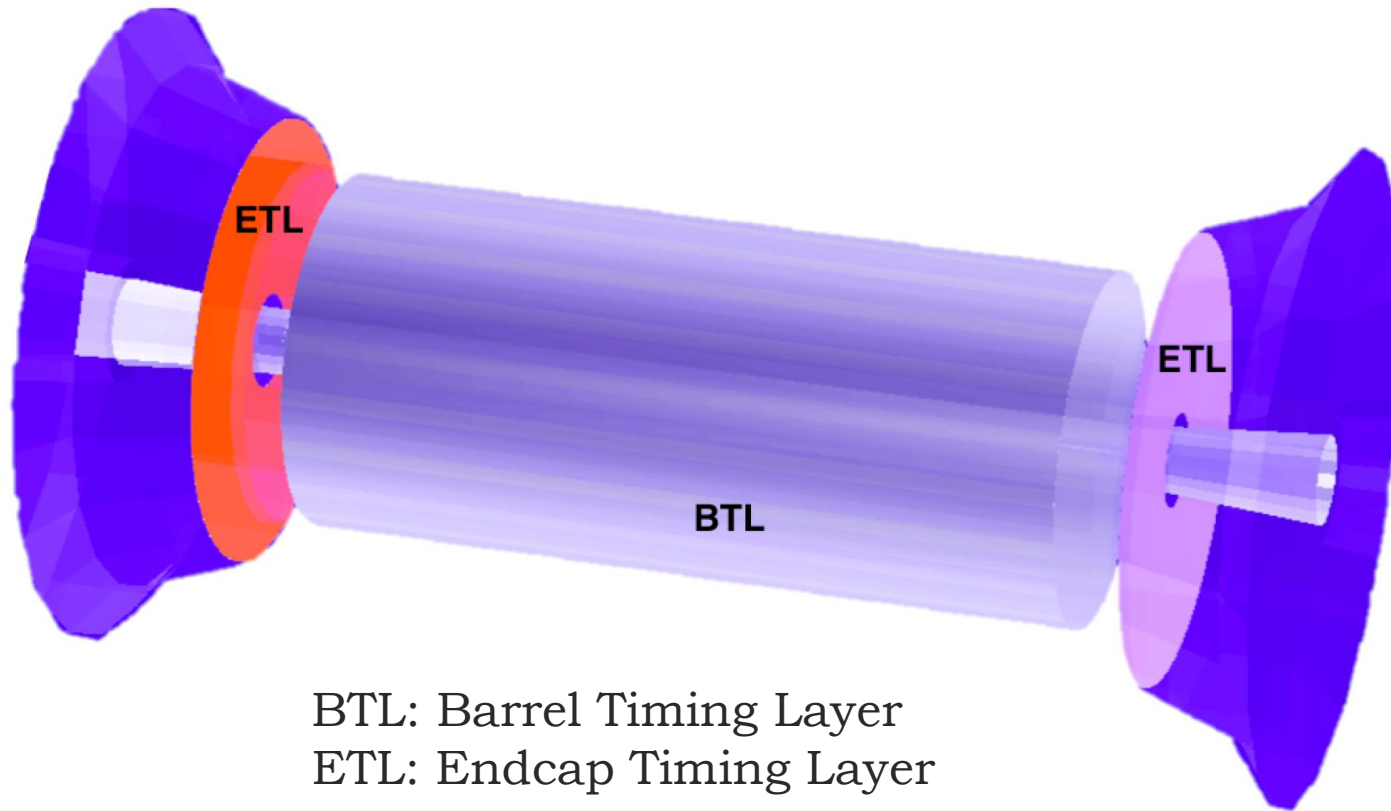
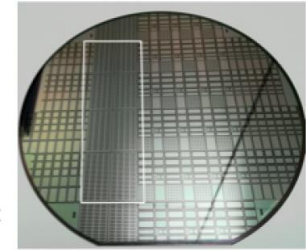
## BTL: LYSO bars + SiPM readout:

- TK / ECAL interface:  $|\eta| < 1.45$
- Inner radius: 1148 mm (40 mm thick)
- Length:  $\pm 2.6$  m along z
- Surface  $\sim 38$  m<sup>2</sup>; 332k channels
- Fluence at  $4 \text{ ab}^{-1}$ :  $2 \times 10^{14} n_{\text{eq}}/\text{cm}^2$



## ETL: Si with internal gain (LGAD):

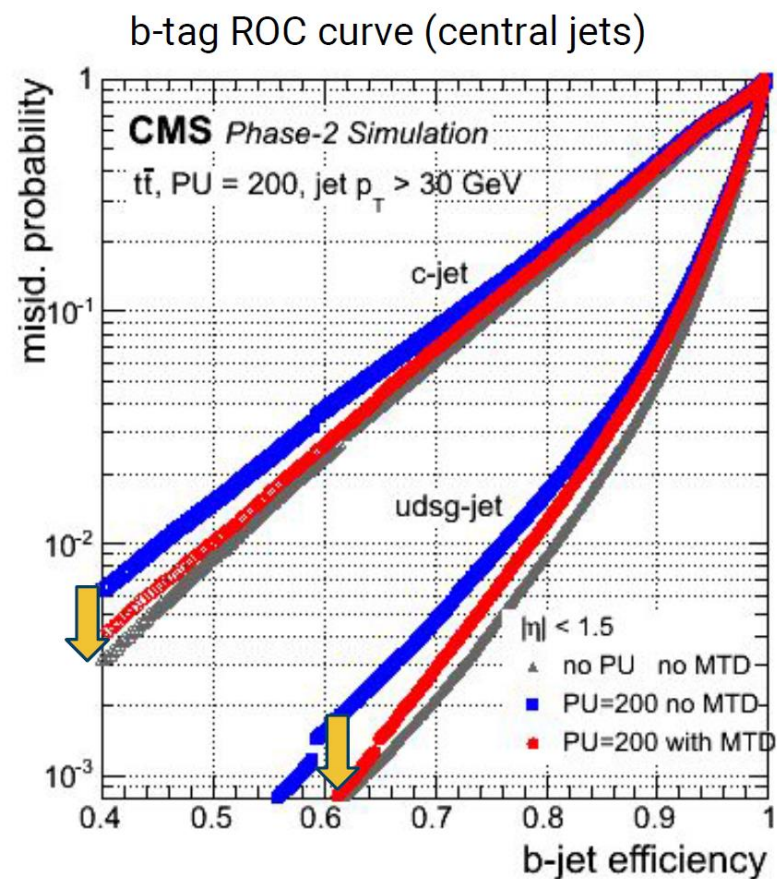
- On the CE nose:  $1.6 < |\eta| < 3.0$
- Radius:  $315 < R < 1200$  mm
- Position in z:  $\pm 3.0$  m (45 mm thick)
- Surface  $\sim 14$  m<sup>2</sup>;  $\sim 8.5$ M channels
- Fluence at  $4 \text{ ab}^{-1}$ : up to  $2 \times 10^{15} n_{\text{eq}}/\text{cm}^2$



BTL: Barrel Timing Layer  
ETL: Endcap Timing Layer

# Improvement in the physics performance with the MTD

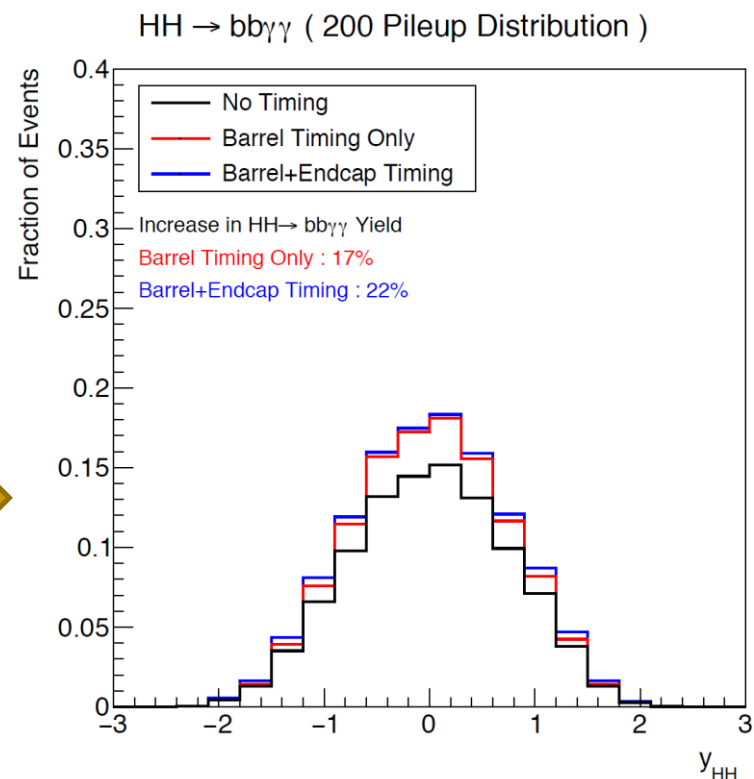
- Reconstruction performance
  - Higher b-tagging efficiency.
  - Improvement in identification and isolation of photons and leptons.
  - Better rejection of fake jets due to pile-up
  - Better missing transverse momentum resolution
  
- Signal yield gain in many Higgs decay channels.
  
- Velocity measurement from TOF:  $\pi/K$  and  $K/p$  discrimination for low  $p_T$  hadrons.





# Improvement in the physics performance with the MTD

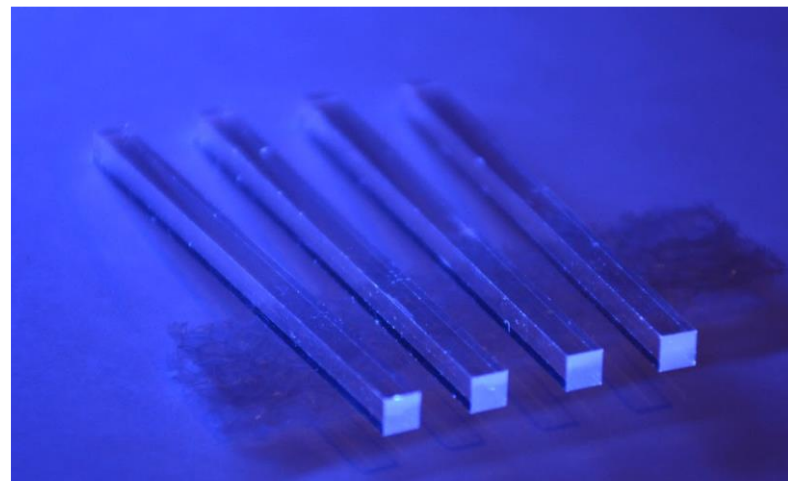
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# MTD barrel: sensor choice

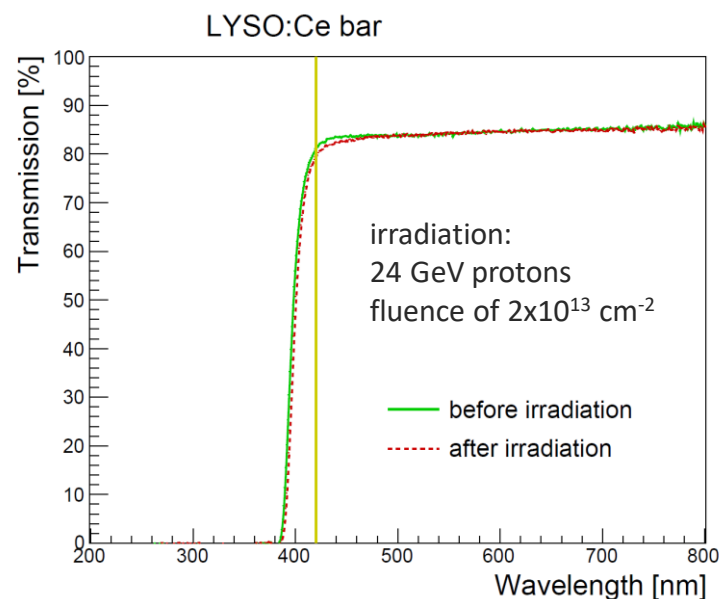
## ■ LYSO:Ce crystal as scintillator

- Dense ( $>7.1 \text{ g/cm}^3$ )
- High light yield (40000 ph/MeV)
- Fast rise time  $O(100)\text{ps}$  and decay time  $\sim 40 \text{ ns}$
- **Excellent radiation tolerance**



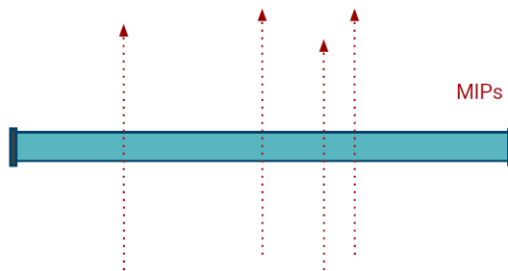
## ■ Silicon Photomultipliers as photo-detectors

- Compact, insensitive to magnetic fields, fast
- High dynamic range
- Good radiation tolerance
- Good Photon Detection Efficiency at 420 nm: 20-40%

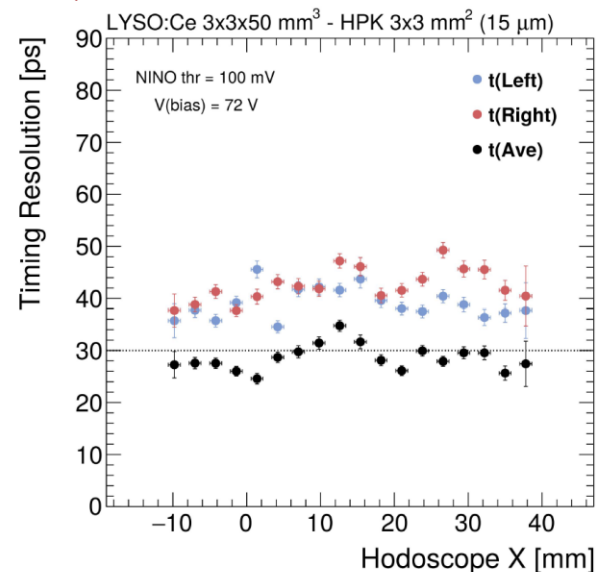
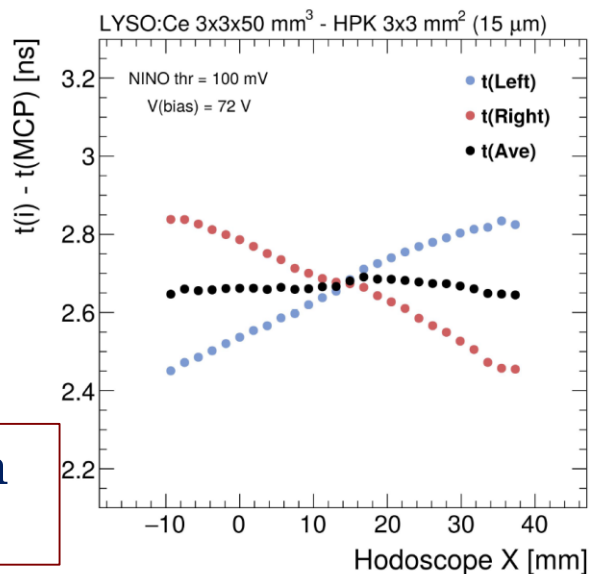


# BTL sensor performance (test beam results)

- **LYSO (3x3x57 mm) bars read-out by SiPMs at both ends** → two different times (left and right) from each channel.
- **Time is sensitive to the light propagation along bar.**
- **Average time:** uniform response vs impact point, resolution improved and around 30 ps (matching requirements)
- **Time difference:** impact point along the bar with O(5 mm) resolution



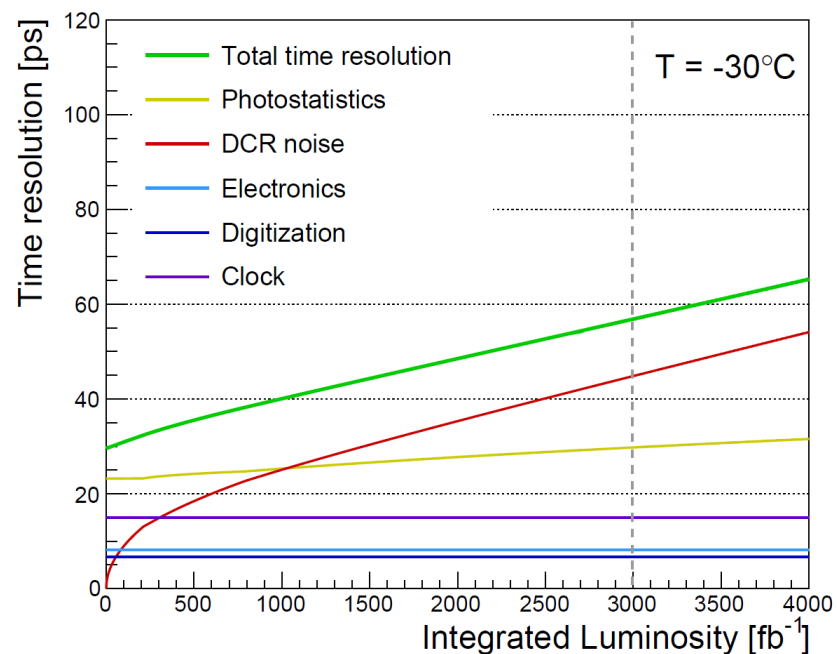
Average MIP deposition  
in LYSO bars ~ 4 MeV.



# [ BTL timing performance ]

- Time resolution will degrade with the LHC integrated luminosity.
- Main contribution from Dark Count Rate due to the SiPM defects induced by irradiation.
  - Mitigation cooling at  $-30\text{ }^{\circ}\text{C}$
  - Possible mitigation with SiPM annealing during downtime.
- Degradation from photostatistics partially mitigated by tuning bias voltage (and therefore PDE).
- Other contributions are stable in time, not affected by irradiation.

$$\sigma_t^{\text{BTL}} = \sigma_t^{\text{clock}} \oplus \sigma_t^{\text{digi}} \oplus \sigma_t^{\text{ele}} \oplus \sigma_t^{\text{phot}} \oplus \sigma_t^{\text{DCR}}$$



# MTD Endcap: the radiation challenge

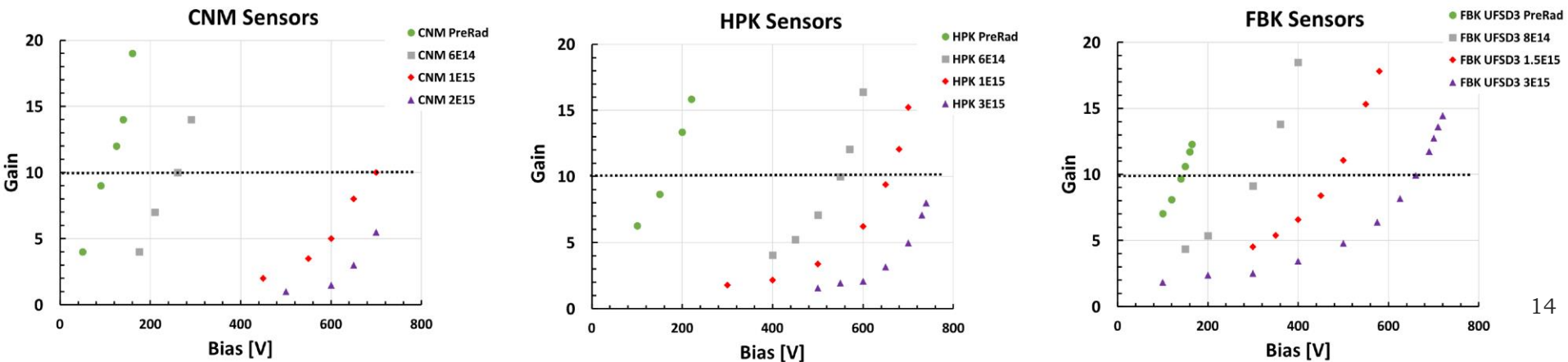
- Higher and non-uniform radiation dose in the Endcap region.
  - A factor 10 in the neutron flux comparing central barrel and outer Endcap
  - A factor 30 in integrated radiation dose.
- SiPM radiation hardness is not adequate for such high doses.
- **Low Gain Avalanche Detectors (LGADs)** will be use in Endcap.
  - Internal gain: 10-30

Region	$ \eta $	$r$ (cm)	$z$ (cm)	$3000 \text{ fb}^{-1}$	
				$n_{\text{eq}}/\text{cm}^2$	Dose (kGy)
Barrel	0.0	117	0	$1.65 \times 10^{14}$	18
Barrel	1.15	117	170	$1.80 \times 10^{14}$	25
Barrel	1.45	117	240	$1.90 \times 10^{14}$	29
Endcap	1.6	127	304	$1.5 \times 10^{14}$	19
Endcap	2.0	84	304	$3.0 \times 10^{14}$	50
Endcap	2.5	50	304	$7.5 \times 10^{14}$	170
Endcap	3.0	30	304	$1.7 \times 10^{15}$	490

# ETL sensor performance: radiation resistance

- The low gain is needed to allow segmentation and to keep the leakage current low. However the goal is to maintain a gain  $> 10$  (resolution  $< 40$  ps) until the end of HL-LHC.
- The gain decreases due to the irradiation: tuning of bias voltage to compensate gain loss.

Gain as a function of bias voltage for different neutron fluences for sensors manufactured by Centro Nacional de Microelectronica (CNM), Hamamatsu Photonics (HPK) and Fondazione Bruno Kessler (FBK).



# [ Conclusions ]

- CMS will upgrade the detector for the HL-LHC (2026-2036) → MTD: a new timing detector to mitigate harsh pile-up conditions.
- This detector will bring a completely new capability to CMS: the ability to measure precisely the production time of MIPs.
- **Barrel Timing Layer:** LYSO:Ce crystals with SiPM readout.
- **Endcap Timing Layer:** LGADs optimized for precision timing.
- Full CMS physics program will benefit: PU reduction, lepton and photon reconstruction, increase of effective luminosity, etc.
- Successful test beam campaign in progress: results show good agreement with expectation.
- A time resolution of 30 ps is achievable both in BTL and ETL; will degrade to only 40-60 ps at the end of HL-LHC.
- **MTD Technical Design Report** will be public in the next few weeks.